

Microsemi 2.5Gbps Ethernet PoE Multiplexer PDS-EM-8100-25



Overview

The PDS-EM-8100-25 PoE 2.5Gbps Multiplexer offers a compact and cost effective solution for 2.5Gbps devices installations such as WLAN access points, small cells and other IP terminal installations.

The PDS-EM-8100-25 converts two copper 1Gbps ports to one port of copper 2.5Gbps, in addition the multiplexer provides PoE to the end device according to IEEE 802.3at up to 30W.

The PDS-EM-8100-25 is un managed and it can be installed out of the box with zero configuration.

Key Features

- Converting 2 x 1G ports into 1 x 2.5Gbps port
- Provides PoE out up to 30Watts
- Plug and play zero configuration needed
- Ability to perform remote SW upgrade

Main Application

 Enables 2.5Gbps interface on the switch side while using the existing 1Gbps switch, the MUX will convert 2 ports of the switch into one 2.5Gbps port that can be connected to the end device (Like 2.5Gbps Access point, 2.5Gbps small cell etc) while providing PoE

Main Benefit

 The Microsemi 2.5G Mux saves the cost and installation time associated with buying and installing a new and expensive 2.5Gbps switch

Specifications

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Feature	Description	
No. of Ports	3	
Data Rates	Port 1 : 2.5Gbps	
	Port 2-3: 10/100/1000 Mbps	
Power over Ethernet	PoE 802.3at on port 1	
Output	Pin Assignment and Polarity:	
	3,6 (+), 1,2 (–)	
	Output Power Voltage: 56Vdc	
User Port Power	30 Watts (Guaranteed)	
LED Indications	SYS	
	PoE	
	Connectors	
Thermal rating	37.75 BTU	
Input Power	AC Input Voltage: 100 to 240Vac AC Input Current: 0.79A @ 100Vac	
Requirements		
	AC Frequency: 50 to 60Hz	
Dimensions	134mm (W) x 38 mm (H) x 158 mm (L)	
Weight	1.84 lbs. (835g)	
Commontor	Shielded RJ-45, EIA 568A and 568B	
Connectors	Shielded RJ-45, EIA 568A and 568B	
Environmental	Shielded RJ-45, EIA 568A and 568B Operating Ambient Temperature:	
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Microsemi 2.5Gbps Ethernet PoE Mux

Ordering Information

Microsemi p/n	Name	Description
PDS-EM-8100-25/AC	Microsemi 2.5Gbps Ethernet PoE Mux	Converting 2 ports of 1Gbps into 1 port of 2.5G interface with 30W PoE



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